

Rev. V1

Designed for use in high–gain, low–noise, ultra–linear, tuned and wideband amplifiers. Ideal for use in CATV, MATV, and instrumentation applications.

• Low noise figure —

NF = 3.0 dB (typ.) @ f = 500 MHz, Ic = 90 mA

High power gain —

GU(max) = 16.5 dB (typ.) @ f = 500 MHz

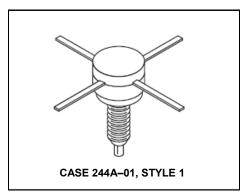
- Ion implanted
- All gold metal system
- High ft 5.5 GHz
- Low intermodulation distortion:

 $TB_3 = -70 \text{ dB}$ 

DIN = 125 dB  $\mu$ V

• Nichrome emitter ballast resistors

#### **Product Image**



#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V <sub>CEO</sub>	17	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	34	Vdc
Emitter–Base Voltage	V <sub>EBO</sub>	2.5	Vdc
Collector Current — Continuous	Ic	200	mAdc
Total Device Dissipation @ T <sub>C</sub> = 50°C Derate above T <sub>C</sub> = 50°C	PD	5.0 33	Watts mW/°C
Storage Temperature Range	T <sub>stg</sub>	- 65 to +150	°C
Junction Temperature	TJ	200	°C

#### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage (I <sub>C</sub> = 5.0 mAdc, I <sub>B</sub> = 0)	V <sub>(BR)CEO</sub>	17	_	_	Vdc
Collector–Base Breakdown Voltage (I <sub>C</sub> = 1.0 mAdc, I <sub>E</sub> = 0)	V <sub>(BR)CBO</sub>		_	_	Vdc
Emitter–Base Breakdown Voltage (I <sub>C</sub> = 0, I <sub>E</sub> = 0.1 mAdc)	V <sub>(BR)EBO</sub>	2.5	_	_	Vdc
Collector Cutoff Current (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0)	I <sub>CBO</sub>	_	_	50	μAdc
ON CHARACTERISTICS					
DC Current Gain (1) (I <sub>C</sub> = 50 mAdc, V <sub>CE</sub> = 5.0 Vdc)	h <sub>FE</sub>	50	_	200	_

NOTE: (continued)

300 μs pulse on Tektronix 576 or equivalent.

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#### **MRF587**



## The RF Line NPN Silicon High Frequency Transistor Noise Figure 3.0 dB@ 500MHz

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ELECTRICAL CHARACTERISTICS — continued (T<sub>C</sub> = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
DYNAMIC CHARACTERISTICS					
Current–Gain — Bandwidth Product (2) (I <sub>C</sub> = 90 mAdc, V <sub>CE</sub> = 15 Vdc, f = 0.5 GHz)	f <sub>T</sub>	_	5.5	_	GHz
Collector-Base Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)	C <sub>cb</sub>	_	1.7	2.2	pF
FUNCTIONAL TESTS					
Narrowband — Figure 15 (I <sub>C</sub> = 90 mA, V <sub>CC</sub> = 15 V, f = 0.5 GHz) Noise Figure Power Gain at Optimum Noise Figure	NF G <sub>NF</sub>	<del>-</del>	3.0 13	4.0	dB
Broadband — Figure 16  (I <sub>C</sub> = 90 mA, V <sub>CC</sub> = 15 V, f = 0.3 GHz)  Noise Figure  Power Gain at Optimum Noise Figure	NF G <sub>NF</sub>	_	6.3 11		dB
Triple Beat Distortion (I <sub>C</sub> = 50 mA, $V_{CC}$ = 15 V, $P_{Ref}$ = 50 dBmV) (I <sub>C</sub> = 90 mA, $V_{CC}$ = 15 V, $P_{Ref}$ = 50 dBmV)	TB <sub>3</sub>	_	-70	_	dB
DIN 45004 (I <sub>C</sub> = 90 mA, V <sub>CC</sub> = 15 V) (I <sub>C</sub> = 90 mA, V <sub>CC</sub> = 15 V)	DIN	_	125	_	dBμV
Maximum Available Power Gain (3) (I <sub>C</sub> = 90 mA, V <sub>CE</sub> = 15 Vdc, f = 0.5 GHz)	G <sub>Umax</sub>	_	16.5	_	dB

#### NOTES:

2. Characterized on HP8542 Automatic Network Analyzer

3. 
$$G_{Umax} = \frac{|S_21|^2}{(1-|S_{11}|^2)(1-|S_{22}|^2)}$$



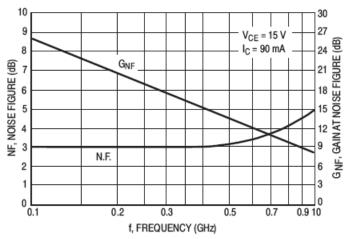


Figure 1. Typical Noise Figure and Associated Gain versus Frequency

Figure 2. Noise Figure versus Collector Current

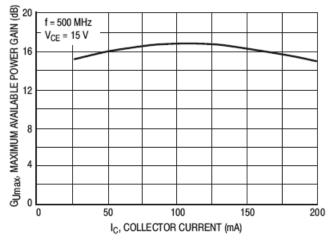


Figure 3. G<sub>Umax</sub> versus Collector Current

Figure 4. Gain-Bandwidth Product versus Collector Current



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#### TYPICAL PERFORMANCE

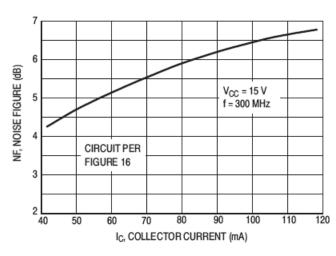


Figure 5. Broadband Noise Figure

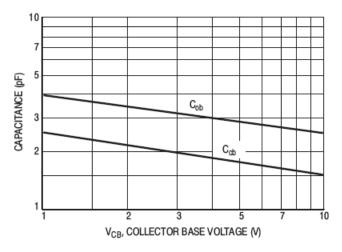


Figure 6. Junction Capacitance versus Voltage

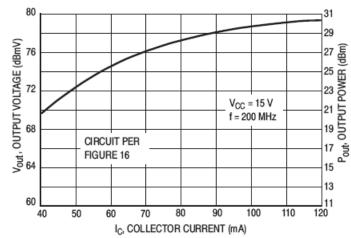


Figure 7. 1.0 dB Compression Point versus Collector Current

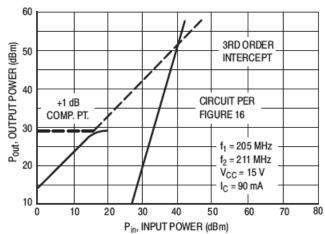


Figure 8. Third Order Intercept Point



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#### TYPICAL PERFORMANCE (continued)

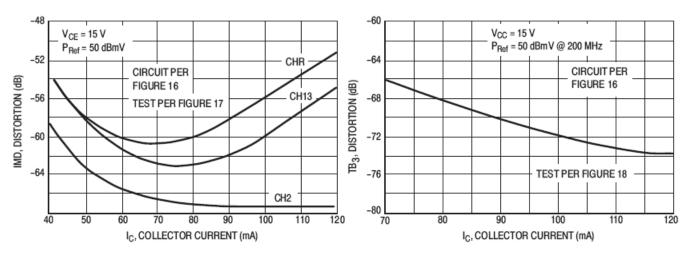


Figure 9. Second Order Distortion versus Collector Current

Figure 10. Triple Beat Distortion versus Collector Current

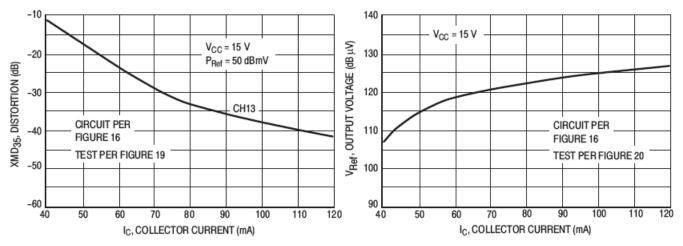


Figure 11. 35-Channel X-Modulation Distortion versus Collector Current

Figure 12. DIN 45004B versus Collector Current



0.6

= 0.1 GHz

02 | 03 | 04 | 05

### The RF Line NPN Silicon High Frequency Transistor Noise Figure 3.0 dB@ 500MHz

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30°

60°

S<sub>12</sub>

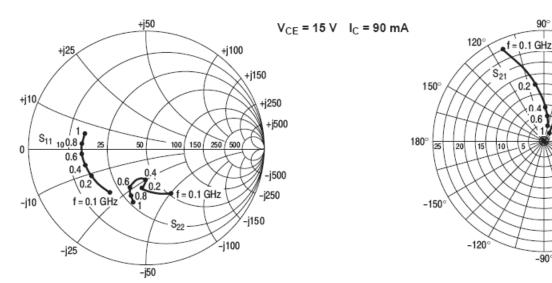


Figure 13. Input/Output Reflection Coefficient versus Frequency (GHz)

Figure 14. Forward/Reverse Transmission Coefficients versus Frequency (GHz)



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V <sub>CE</sub>	lc.	f	S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>		S <sub>22</sub>	
(Volts)	(mA)	(MHz)	S <sub>11</sub>	∠ φ	S <sub>21</sub>	∠ ф	S <sub>12</sub>	∠ ф	S <sub>22</sub>	∠ φ
5.0	30	100 200	0.56 0.58	-131 -159	16.45 9.42	113 98	0.04 0.06	45 49	0.49 0.38	-91 -116
		400	0.60	-178	5.00	86	0.08	55	0.35	-132
		600	0.64	170	3.61	76	0.11	56	0.38	-138
		800	0.67	162	2.92	67	0.14	55	0.41	-144
		1000	0.70	155	2.55	58	0.17	54	0.44	-152
	60	100	0.53	-141	17.89	110	0.04	50	0.47	-102
		200	0.56	-164	10.05	97	0.05	55	0.39	-126
		400	0.59	178	5.31	85	0.09	60	0.38	-141 -146
		600 800	0.63 0.66	169 161	3.82 3.09	76 67	0.12 0.15	59 57	0.40 0.44	-146 -153
		1000	0.69	155	2.67	58	0.13	55	0.47	-160
	90	100	0.52	-145	18.26	109	0.04	52	0.47	-106
		200	0.56	-166	10.20	96	0.05	57	0.39	-130
		400	0.59	177	5.38	85	0.09	62	0.39	-144
		600	0.63	168	3.86	76	0.12	60	0.41	-149
		800	0.66	161	3.12	67	0.15	58	0.45	-155
		1000	0.69	155	2.70	58	0.19	55	0.48	-162
10	30	100	0.53	-122	18.36	115	0.04	48	0.50	-75
		200 400	0.53 0.55	-153 175	10.63 5.71	100 87	0.05 0.08	51 57	0.36 0.33	-96 -112
		600	0.55	173	4.16	78	0.00	58	0.35	-112
		800	0.62	165	3.37	68	0.10	57	0.39	-127
		1000	0.65	158	2.95	59	0.15	55	0.42	-136
	60	100	0.49	-132	20.19	112	0.03	51	0.46	-85
		200	0.51	-158	11.54	99	0.05	57	0.35	-107
		400	0.53	-178	6.12	87	0.08	61	0.33	-123
		600	0.58	171	4.43	78	0.11	60	0.36	-129
		800 1000	0.60 0.63	164 157	3.58 3.12	68 60	0.14 0.16	59 57	0.40 0.44	-136 -144
	90	1000	0.48	-135	20.82	111	0.10	53	0.44	-88
	30	200	0.50	-160	11.77	98	0.05	55 59	0.45	-111
		400	0.53	-179	6.22	86	0.08	63	0.33	-126
		600	0.57	171	4.50	78	0.11	62	0.36	-131
		800	0.60	164	3.64	68	0.14	59	0.41	-139
		1000	0.63	157	3.18	60	0.17	57	0.44	-147

(continued)

Table 1. Common-Emitter S-Parameters

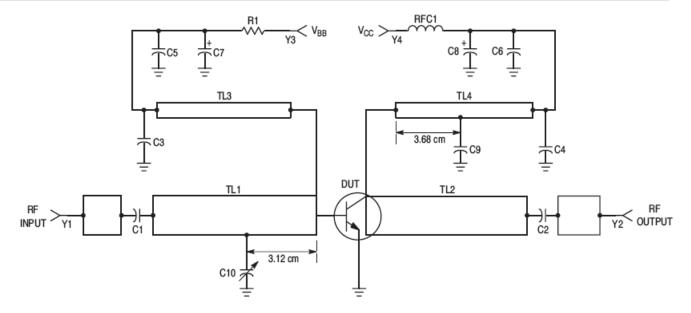


V <sub>CE</sub>	Ic	f	s	11	S <sub>21</sub>		S <sub>12</sub>		S <sub>22</sub>	
(Volts)	(mA)	(MHz)	S <sub>11</sub>	∠ ф	S <sub>21</sub>	∠ ф	S <sub>12</sub>	∠ ф	S <sub>22</sub>	∠ ф
15	30	100	0.49	-112	20.34	118	0.04	54	0.51	-52
		200	0.52	-145	11.51	101	0.05	56	0.36	-77
		400	0.48	-164	6.12	87	0.09	63	0.32	-74
		600	0.52	-174	4.19	75	0.12	62	0.32	-90
		800	0.53	177	3.29	68	0.16	61	0.38	-90
		1000	0.53	168	2.76	61	0.20	56	0.47	-90
	60	100	0.45	-122	22.14	115	0.03	56	0.45	-60
		200	0.49	-150	12.24	99	0.05	60	0.33	-86
		400	0.45	-166	6.45	86	0.09	65	0.30	-83
		600	0.50	-175	4.42	75	0.13	63	0.32	-99
		800	0.51	177	3.47	68	0.16	61	0.38	-98
		1000	0.51	168	2.91	62	0.20	55	0.46	-96
	90	100	0.44	-127	22.76	114	0.03	58	0.43	-62
		200	0.48	-152	12.44	98	0.05	62	0.32	-89
		400	0.44	-167	6.55	85	0.09	66	0.29	-85
		600	0.50	-176	4.47	75	0.13	64	0.32	-102
		800	0.51	176	3.51	69	0.17	61	0.38	-100
		1000	0.51	168	2.95	62	0.20	55	0.46	-98

Table 1. Common-Emitter S-Parameters (continued)



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C1, C2 - 470 pF Chip (Ceramic)

C3, C4 - 0.018 µF Chip Capacitor

C5, C6 - 0.1 µF Mylar

C7, C8 - 1.0 µF, 25 Vdc Electrolytic

C9 - 91 pF Mini-Unelco (C9 Taped 3.68 cm from Collector Connection on TL4 as shown)

C10 — 35-45 pF Johanson Ceramic Capacitor, JMC 5801 or Equivalent (C10 Taped 3.12 cm from Base Connection on TL1)

R1 — 2.7 kΩ, 1-1/2 W

RFC1 - 0.15 µH Molded Choke

TL1, TL2 —  $Z_0$  = 26  $\Omega$ , 0.0625 TFG as shown in

Photomaster

TL3, TL4 —  $\lambda/4$  Microstrip,  $Z_0 = 100 \Omega$ 

Y1, Y2 - N-Type Connection (Female)

Y3, Y4 — BNC-Type Connector (Female)

Board Material — 0.0625'' Thick Glass Teflon  $\varepsilon_r = 2.5$ 

Figure 15. Narrowband Test Fixture Schematic 500 MHz



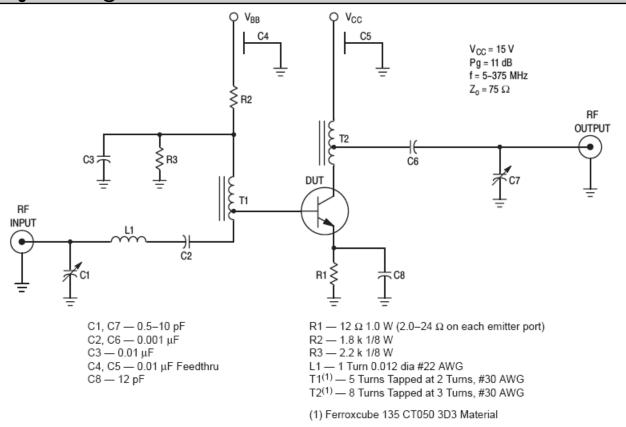


Figure 16. Broadband Test Circuit Schematic



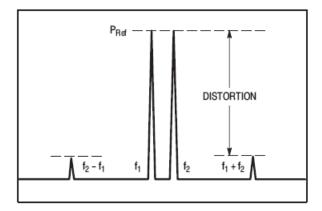


Figure 17. Second Order Distortion Test

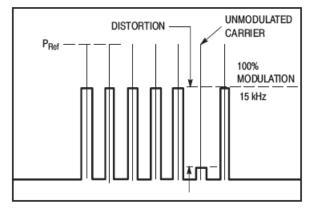


Figure 19. Cross Modulation Distortion Test

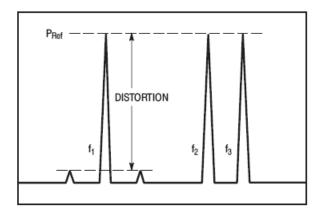


Figure 18. Triple Beat Distortion Test

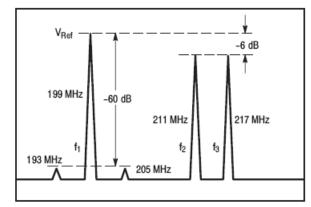
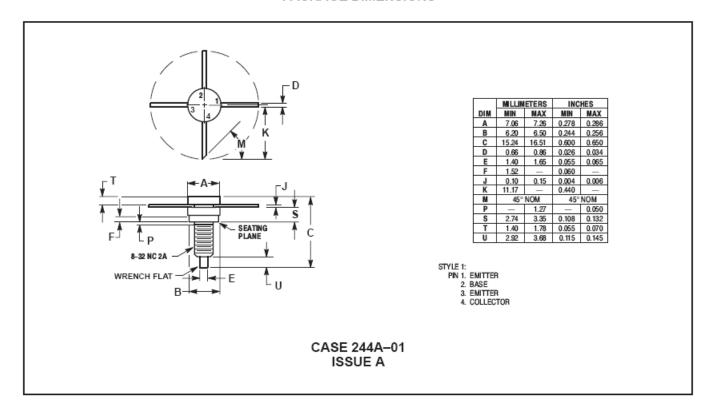


Figure 20. DIN 45004B Intermodulation Test



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#### PACKAGE DIMENSIONS



#### **MRF587**



The RF Line NPN Silicon High Frequency Transistor Noise Figure 3.0 dB@ 500MHz

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